

# AOT292L/AOB292L/AOTF292L

100V N-Channel AlphaSGT™

### **General Description**

• Trench Power AlphaSGT<sup>TM</sup> technology

• Low R<sub>DS(ON)</sub>

• RoHS and Halogen Free Compliant

# **Product Summary**

 $V_{DS}$  100V  $I_{D}$  (at  $V_{GS}$ =10V) 105A

$$\begin{split} R_{DS(ON)} & (\text{at V}_{GS} \text{=} 10\text{V}) \\ R_{DS(ON)} & (\text{at V}_{GS} \text{=} 6\text{V}) \\ \end{split} \qquad \begin{array}{l} < 4.5\text{m}\Omega \quad (< 4.1\text{m}\Omega^*) \\ < 5.3\text{m}\Omega \quad (< 4.9\text{m}\Omega^*) \\ \end{array}$$

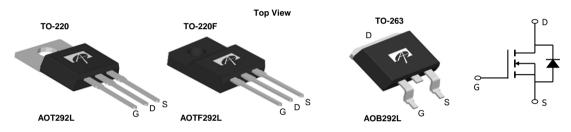
## **Applications**

• Synchronous Rectification for power supply

Ideal for boost converters

100% UIS Tested 100% Rg Tested





Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT292L	TO-220	Tube	1000
AOTF292L	TO-220F	Tube	1000
AOB292L	TO-263	Tape & Reel	800

## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Parameter	•	Symbol	AOT(B)292L	AOTF292L	Units	
Drain-Source Voltage		V <sub>DS</sub>	100		V	
Gate-Source Voltage	Э	$V_{GS}$	±	-20	V	
Continuous Drain	ontinuous Drain T <sub>C</sub> =25°C		105	70		
Current G**	T <sub>C</sub> =100°C	I <sub>D</sub>	82	50	Α	
Pulsed Drain Current <sup>C</sup>		I <sub>DM</sub>	420			
Continuous Drain	T <sub>A</sub> =25°C	I <sub>DSM</sub>	14.5		Δ.	
Current	T <sub>A</sub> =70°C		11.5		Α	
Avalanche Current C	;	I <sub>AS</sub>	(	60	Α	
Avalanche energy	L=0.1mH <sup>C</sup>	E <sub>AS</sub>	180		mJ	
V <sub>DS</sub> Spike <sup>1</sup>	10µs	V <sub>SPIKE</sub>	120		V	
	T <sub>C</sub> =25°C	P <sub>D</sub>	300	47	107	
Power Dissipation <sup>B</sup>	T <sub>C</sub> =100°C		150	23	W	
	T <sub>A</sub> =25°C	В	2.1		14/	
Power Dissipation <sup>A</sup>	T <sub>A</sub> =70°C	P <sub>DSM</sub>	1.3		W	
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 175		°C	

Thermal Characteristics						
Parameter		Symbol	AOT(B)292L	AOTF292L	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	D	15		°C/W	
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	60		°C/W	
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	0.5	3.2	°C/W	

<sup>\*</sup> Surface mount package TO263

<sup>\*\*</sup> Package limited for TO220 & TO263



### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units		
STATIC PARAMETERS								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D=250\mu A, V_{GS}=0V$	100			V		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1			
		T <sub>J</sub> =55°C			5	μA		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±20V			±100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.3	2.8	3.4	V		
	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		3.7	4.5	mΩ		
		TO220/TO220F T <sub>J</sub> =125°C		6.1	7.4	11132		
		$V_{GS}$ =6V, $I_D$ =20A						
R <sub>DS(ON)</sub>		TO220/TO220F		4.2	5.3	mΩ		
		$V_{GS}$ =10V, $I_D$ =20A						
		TO263		3.3	4.1	mΩ		
		$V_{GS}$ =6V, $I_D$ =20A						
		TO263		3.8	4.9	mΩ		
g <sub>FS</sub>	Forward Transconductance	$V_{DS}=5V$ , $I_{D}=20A$		90		S		
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =1A, V <sub>GS</sub> =0V		0.68	1	V		
I <sub>S</sub>	Maximum Body-Diode Continuous Curr	ent(TO220/TO263) G			105	Α		
.5	Maximum Body-Diode Continuous Curr	rent(TO220F)			50	Α		
	PARAMETERS							
C <sub>iss</sub>	Input Capacitance			6775		pF		
C <sub>oss</sub>	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =50V, f=1MHz		557		pF		
C <sub>rss</sub>	Reverse Transfer Capacitance			32		pF		
$R_g$	Gate resistance	f=1MHz	0.4	8.0	1.2	Ω		
SWITCHI	NG PARAMETERS							
Q <sub>g</sub> (10V)	Total Gate Charge			90	126	nC		
Q <sub>g</sub> (4.5V)	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =20A		40	60	nC		
$Q_{gs}$	Gate Source Charge			24		nC		
$Q_{gd}$	Gate Drain Charge			13.5		nC		
t <sub>D(on)</sub>	Turn-On DelayTime			20		ns		
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =50V, $R_L$ =2.5 $\Omega$ ,		11.5		ns		
t <sub>D(off)</sub>	Turn-Off DelayTime	$R_{GEN}=3\Omega$		48		ns		
t <sub>f</sub>	Turn-Off Fall Time			10		ns		
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =20A, di/dt=500A/μs		50		ns		
$Q_{rr}$	Body Diode Reverse Recovery Charge	I <sub>F</sub> =20A, di/dt=500A/μs		380		nC		

A. The value of R<sub>bJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25° C. The Power dissipation P<sub>DSM</sub> is based on R <sub>0JA</sub> I≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175° C may be used if the PCB allows it.

- C. Single pulse width limited by junction temperature  $T_{J(MAX)}$ =/175° C. D. The  $R_{0JA}$  is the sum of the thermal impedance from junction to case  $R_{0JC}$  and case to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 $\mu$ s pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=175° C. The SOA curve provides a single pulse rating.
- G. The maximum current rating is package limited.

  H. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with  $T_A$ =25° C.
- I. L=100uH, Fsw=1Hz, Tj≤150C by repetitive UIS.

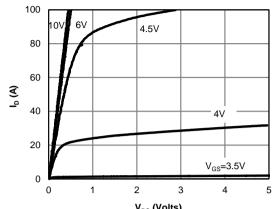
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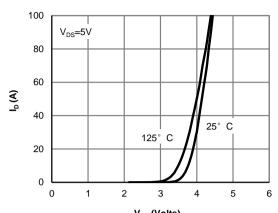
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B. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=175° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

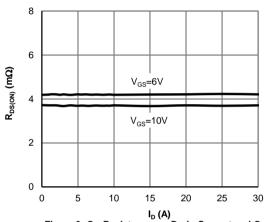




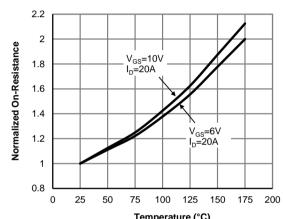
 $V_{\rm DS}$  (Volts) Figure 1: On-Region Characteristics (Note E)



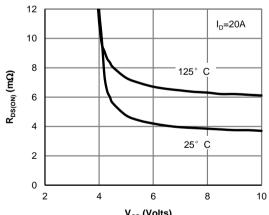
V<sub>GS</sub> (Volts) Figure 2: Transfer Characteristics (Note E)



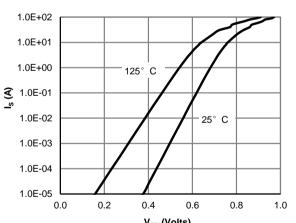
 $\label{eq:local_local} \textbf{I}_{\text{D}}\left(\textbf{A}\right)$  Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)

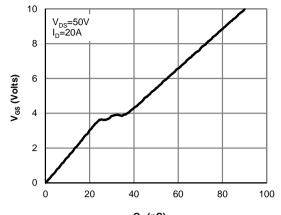


V<sub>GS</sub> (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage
(Note E)

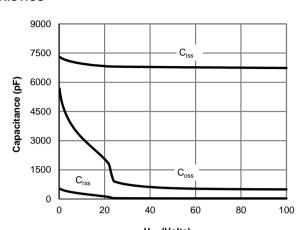


V<sub>SD</sub> (Volts) Figure 6: Body-Diode Characteristics (Note E)

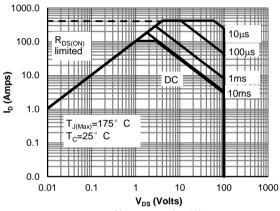




 ${\bf Q_g}$  (nC) Figure 7: Gate-Charge Characteristics



 $V_{DS}$  (Volts) Figure 8: Capacitance Characteristics



 $V_{\rm GS}{\!>}$  or equal to 6V Figure 9A: Maximum Forward Biased Safe Operating Area for TO220 & TO263 (Note F)

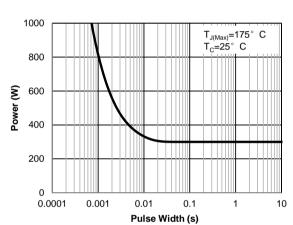
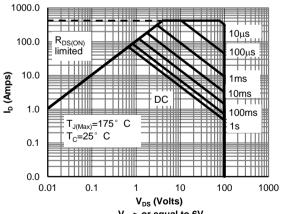
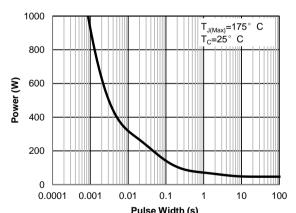


Figure 10A: Single Pulse Power Rating Junction-to-Case for TO220 & TO263 (Note F)



V<sub>GS</sub>- or equal to 6V Figure 9B: Maximum Forward Biased Safe Operating Area for TO220F (Note F)



Pulse Width (s)
Figure 10B: Single Pulse Power Rating Junction-toCase for TO220F (Note F)

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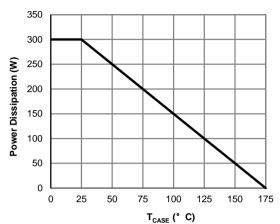
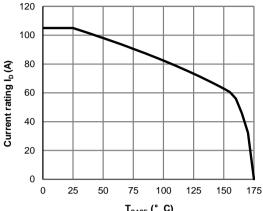


Figure 11A: Power De-rating for TO220 & TO263 (Note F)



T<sub>CASE</sub> (° C) Figure 12A: Current De-rating for TO220 & TO263 (Note F)

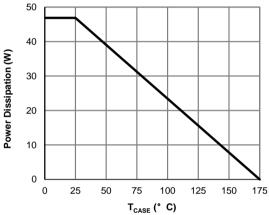
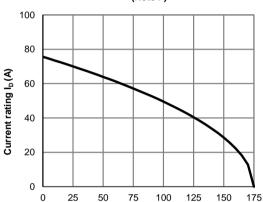
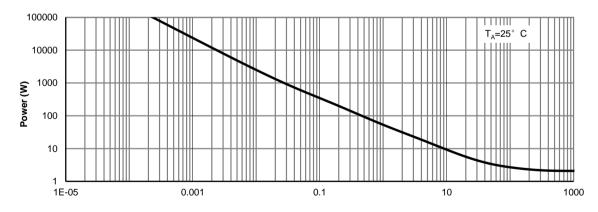


Figure 11B: Power De-rating for TO220F (Note F)



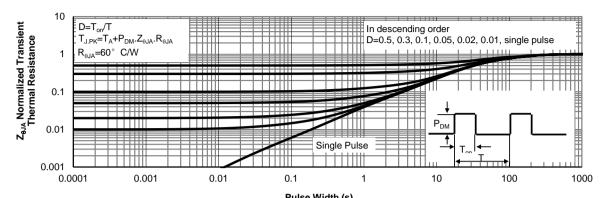
T<sub>CASE</sub> (° C)
Figure 12B: Current De-rating for TO220F
(Note F)



Pulse Width (s)
Figure 13: Single Pulse Power Rating Junction-to-Ambient (Note H)

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Pulse Width (s)
Figure 14: Normalized Maximum Transient Thermal Impedance (Note H)

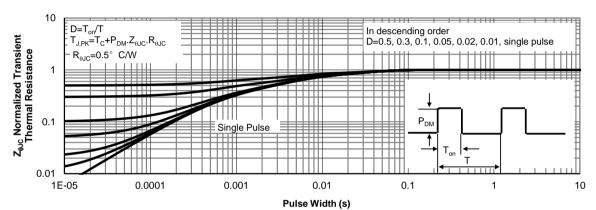


Figure 15A: Normalized Maximum Transient Thermal Impedance for TO220 & TO263 (Note F)

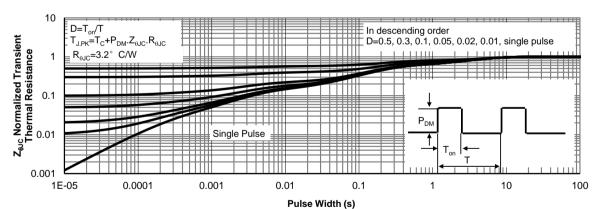


Figure 15B: Normalized Maximum Transient Thermal Impedance for TO220F (Note F)

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Figure A: Gate Charge Test Circuit & Waveforms

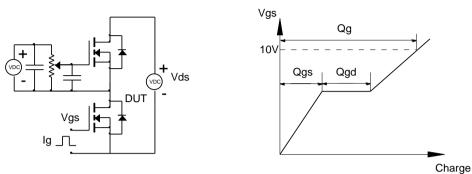


Figure B: Resistive Switching Test Circuit & Waveforms

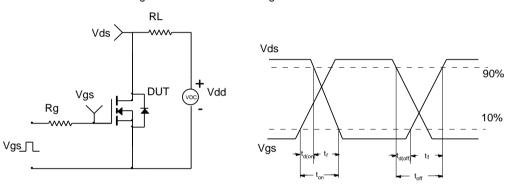


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

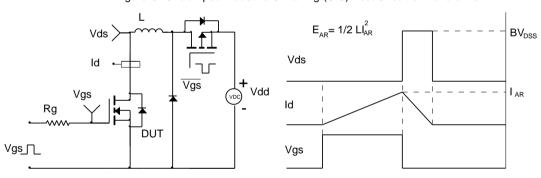
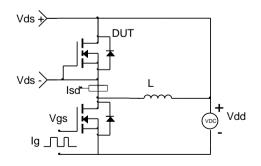
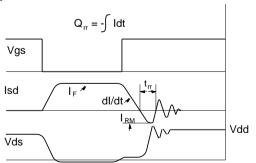


Figure D: Diode Recovery Test Circuit & Waveforms





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